

Midas Components Limited Electra House 32 Southtown Road Great Yarmouth Norfolk NR31 0DU England Telephone Fax Email Website +44 (0)1493 602602 +44 (0)1493 665111 sales@midasdisplays.com www.midasdisplays.com

Specification					
Part Number:	MCCOG21608A6W-FPTLWI				
Version:	1				
Date:	20/03/2015				
Revision					



# Contents

- 1.General Specification
- 2. Module Classification Information
- 3.Interface Pin Function
- 4. Contour Drawing
- 5. Optical Characteristics
- 6. Absolute Maximum Ratings
- 7. Electrical Characteristics
- 8.Backlight Information
- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of LCD Modules U = 5U D V
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

## 1.General Specification

Number of Characters: 16 characters x 2 Lines

■ Module dimension: 85.0\*30.0\*6.2 mm

View area: 76.0\*18.0 mm

Active area: 73.81\*15.88 mm

■ Dot size: 0.75\*0.9 mm

■ Dot pitch: 0.79\*0.97 mm

■ Character size: 3.91\*7.69 mm

■ Character pitch: 4.66\*8.19 mm

LCD type: FSTN Positive Transflective,

■ Duty: 1/16 , 1/5 Bias

■ View direction: 6 o'clock

■ Backlight Type: LED, White

■ IC: ST7032i Sign • manufacture • supply

#### Midas LCD Part Number System

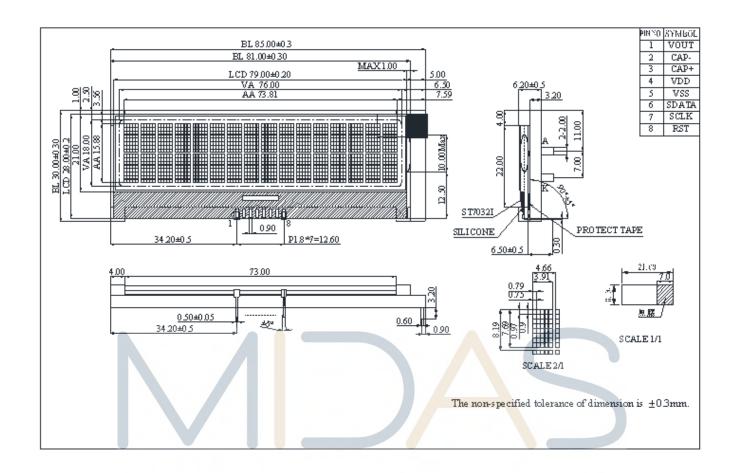
```
MC
        COG
                 132033
                                 Α
                                                                                 S
 1
          2
                      3
                                 4
                                        5
                                               6
                                                      7
                                                             8
                                                                    9
                                                                                10
                                                                                       11
                                                                                               12
                                                                                                      13
                                                                                                              14
                                                                                                                     15
                                                                                                                            16
1
                   MC: Midas Components
2
         =
                   Blank: COB (chip on board) COG: chip on glass
3
         =
                   No of dots
                                      (e.g. 240064 = 240 \times 64 \text{ dots})
                                                                             (e.g. 21605 = 2 \times 16 5 mm C.H.)
                   Series
4
                   Series Variant:
                                      A to Z - see addendum
5
                   3: 3 o'clock
                                                         9: 9 o'clock
                                                                             12: 12 o'clock
                                      6: 6 o'clock
6
7
                   S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)
8
                   Character Set
                   Blank: Standard (English/Japanese)
                   C: Chinese Simplified (Graphic Displays only)
                   CB: Chinese Big 5 (Graphic Displays only)
                   H: Hebrew
                   K: European (std) (English/German/French/Greek)
                   L: English/Japanese (special)
                   M: European (English/Scandinavian)
                   R: Cyrillic
                   W: European (English/Greek)
                   U: European (English/Scandinavian/Icelandic)
                   J: Asian/Arabic
9
         =
                   Bezel Height (where applicable / available)
                                                       Common
                                                                     Array
                             Top of Bezel to Top
                                                                     or Edge
                                                      (via pins 1
                                    of PCB
                                                        and 2)
                                                                       Lit
                             9.5mm / not
                    Blank
                                                       Common
                                                                     Array
                             applicable
                    2
                             8.9 \mathrm{mm}
                                                       Common
                                                                     Array
                    3
                             7.8 \; \mathrm{mm}
                                                       Separate
                                                                     Array
                    4
                             7.8 \ \mathrm{mm}
                                                       Common
                                                                     Array
                    5
                             9.5 \text{ mm}
                                                       Separate
                                                                     Array
                    6
                             7~\mathrm{mm}
                                                       Common
                                                                     Array
                    7
                             7~\mathrm{mm}
                                                       Separate
                                                                      Array
                    8
                             6.4 \ \mathrm{mm}
                                                       {\bf Common}
                                                                      Edge
                    9
                             6.4 \text{ mm}
                                                       Separate
                                                                      Edge
                    A
                             5.5 \text{ mm}
                                                       Common
                                                                      Edge
                    В
                             5.5 \text{ mm}
                                                       Separate
                                                                      Edge
                    D
                             6.0mm
                                                       Separate
                                                                      Edge
                    \mathbf{E}
                             5.0mm
                                                       Separate
                                                                      Edge
                             4.7mm
                                                                      Edge
                    F
                                                       Common
                    G
                             3.7mm
                                                       Separate
                                                                       \mathbf{EL}
10
         =
                   T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN V: VATN Z: Zero Power (Bi-Stable)
11
         =
                   P: Positive N: Negative
12
         =
                   R: Reflective M: Transmissive T: Transflective
13
                   Backlight: Blank: Reflective L: LED
14
                   Backlight Colour: Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.
                   If Z (Zero Power): WB: White on blue GB: Green on black YB: Yellow on black YPB: Yellow on pink and/or blue
15
         =
                   Driver Chip:
                                      Blank: Standard I: I<sup>2</sup>C T: Toshiba T6963C A: Avant SAP1024B R: Raio RA8835
```

Voltage Variant: e.g. 3 = 3v

# 3.Interface Pin Function

Pin No.	Symbol	Level	Description
1	VOUT		DC/DC voltage converter. Connect a capacitor between this terminal and VIN when the built-in booster is used.
2	CAP-		For voltage booster circuit(VDD-VSS)
3	CAP+		External capacitor about 0.1u~4.7uf
4	VDD	3.0/5.0V	Power supply
5	VSS		GND
6	SDATA		(In I2C interface DB7 (SDATA) is input data. SDATA and SCLK must connect to I2C bus (I2C bus is to connect a resister between SDATA/ SCLK and the power of I2C bus).
7	SCLK		(In I2C interface DB6 (SCLK) is clock input.  SDA and SCLK must connect to I2C bus (I2C bus is to connect a resister between SDATA/SCLK and the power of I2C bus).
8	RST		RESET (Low active)
	desig	n • r	manufacture • supply

## **4.Contour Drawing**

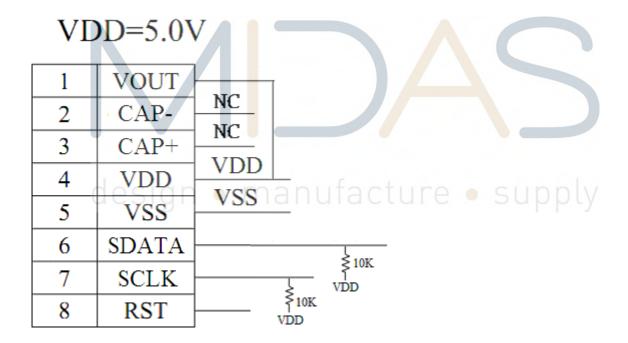


design • manufacture • supply

# **Application schematic**

VDD=3.0V

1	VOUT	
2	CAP-	
3	CAP+	TIUF TIUF
4	VDD	VDD TIEF
5	VSS	VSS
6	SDATA	<u> </u>
7	SCLK	\$10K 
8	RST	



INITIALIZE: (3V)

MOV I2C\_CONTROL,#00H; WRITE COMMAND

MOV I2C\_DATA,#38H ;Function Set

LCALL WRITE\_CODE

MOV I2C\_CONTROL,#00H; WRITE COMMAND

MOV I2C\_DATA,#39H ;Function Set

LCALL WRITE CODE

MOV I2C\_DATA,#14H ;Internal OSC frequency

LCALL WRITE\_CODE

MOV I2C\_DATA,#74H ;Contrast set

LCALL WRITE\_CODE

MOV I2C\_DATA,#54H ;Power/ICON control/Contrast set

LCALL WRITE\_CODE

MOV I2C\_DATA,#6FH ;Follower control

LCALL WRITE\_CODE

MOV I2C\_DATA,#0CH ;Display ON/OFF

LCALL WRITE\_CODE

MOV I2C\_DATA,#01H ;

LCALL WRITE\_CODE

;Clear Display

#### **INITIALIZE: (5V)**

MOV I2C\_CONTROL,#00H;WRITE COMMAND

MOV I2C\_DATA,#38H ;Function Set

LCALL WRITE\_CODE

MOV I2C\_CONTROL,#00H;WRITE COMMAND

MOV I2C\_DATA,#39H ;Function Set

LCALL WRITE\_CODE

MOV I2C\_DATA,#14H ;Internal OSC frequency

LCALL WRITE\_CODE

MOV I2C\_DATA,#79H ;Contrast set

LCALL WRITE\_CODE

MOV I2C\_DATA,#50H ;Power/ICON control/Contrast set

LCALL WRITE\_CODE

MOV I2C\_DATA,#6CH ;Follower control

LCALL WRITE\_CODE

MOV I2C\_DATA,#0CH ;Display ON/OFF

LCALL WRITE\_CODE

MOV I2C\_DATA,#01H ;Clear Display

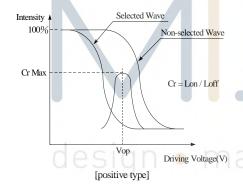
LCALL WRITE CODE

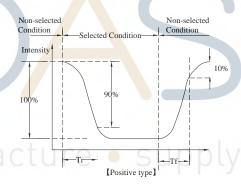
# **5.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR <b>≧</b> 2	0	_	30	ψ= 180°
View Angle	θ	CR <b>≥</b> 2	0	_	60	ψ= 0°
View Angle	θ	CR≧2	0	_	45	ψ= 90°
	θ	CR <b>≧</b> 2	0	_	45	ψ= 270°
Contrast Ratio	CR	_	_	5	_	_
Daga Time	T rise	_	_	150	200	ms
Response Time	T fall	_	_	150	200	ms

### **Definition of Operation Voltage (Vop)**

### Definition of Response Time (Tr, Tf)

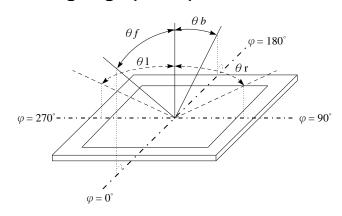




#### **Conditions:**

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

### **Definition of viewing angle(CR≥2)**



# **6.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	
Storage Temperature	Тѕт	-30	_	+80	
Input Voltage	V <sub>IN</sub>	-0.3	_	V <sub>DD</sub> +0.3	V
Power Supply Voltage	V <sub>DD</sub> -V <sub>SS</sub>	-0.3	_	+6.0	V
LCD Driver Voltage	V <sub>LCD</sub>	2.7	_	7.0	٧



## 7. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
					5	
Supply Voltage For Logic	V <sub>DD</sub> -V <sub>SS</sub>	_	3	3.3	(bon=1	V
					max=3.5V)	
		Ta=-20		_		٧
Supply Voltage For LCD	VLCD	Ta=25	4.3	4.5	4.7	V
		Ta=70	_	_	_	V
Input High Volt.	ViH	1	0.7 V <sub>DD</sub>	_	V <sub>DD</sub>	V
Input Low Volt.	VIL		7	-	0.2 V <sub>DD</sub>	٧
Output High Volt.	Vон	-	0.8 V <sub>DD</sub>	_	V <sub>DD</sub>	V
Output Low Volt.	Vol	-//		1	0.2V <sub>DD</sub>	V
Supply Current(No						A
include LED Backlight)	IDD	- -	150	_	2.0	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

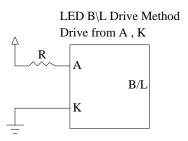
# 8.Backlight Information

### **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	_	32	40	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	
Reverse Voltage	VR	_	_	5	٧	_
Color	Х	0.24	0.26	0.28		V=3.5V
coordinate	Y	0.25	0.27	0.29		V=3.5V
Luminance (Without LCD)	IV	536	670	-	CD/M <sup>2</sup>	ILED=32mA
LED Life Time	/-	ļ	50000		Hr.	ILED≦32 mA 25 ,50-60%RH Note1
Color desi	White	ma	nufa	actu	ire •	supply

Note: The LED of B/L is drive by current only; driving voltage is only for reference To make driving current in safety area (waste current between minimum and maximum).

Note1:50K hours is only an estimate for reference.



# 9.Reliability

### Content of Reliability Test (Wide temperature, -20 ~70 )

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60 ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20 25 70	-20 /70 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude:  1.5mm  Vibration Frequency:  10~55Hz  One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

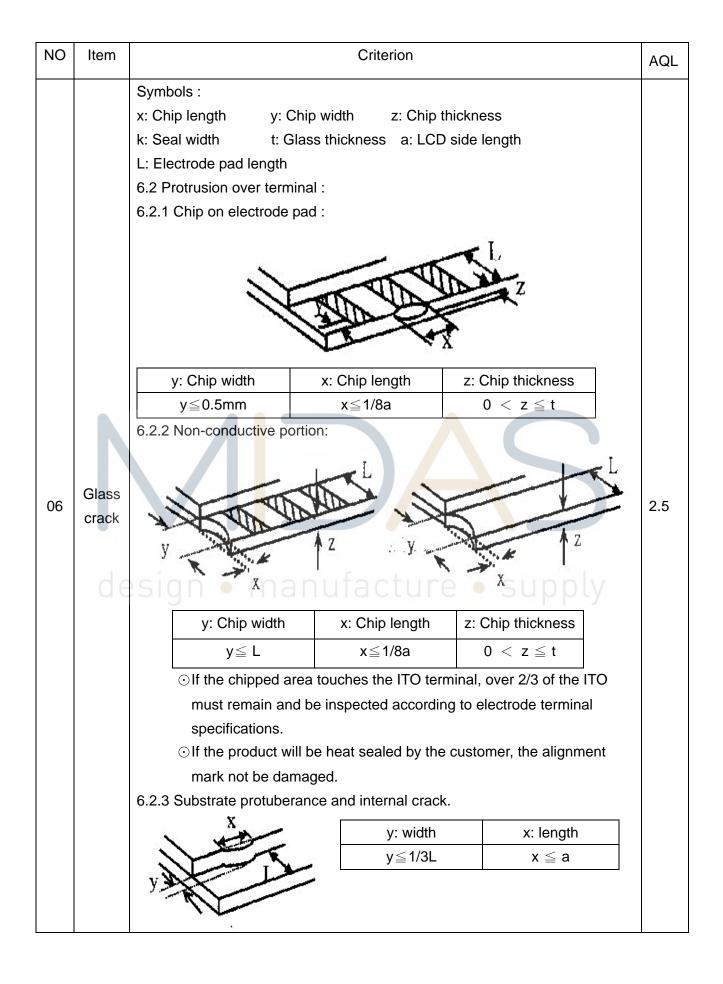
Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

# 10.Inspection specification

NO	Item			Criterion		AQL
01	Electrical Testing	defect. 1.2 Missing chara 1.3 Display malfu 1.4 No function of	acter, do unction. or no displumption eangle defeat types.	ay. exceeds product sp		0.65
02	Black or white spots on LCD (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>				2.5
03	LCD black spots, white spots, contamination	3.1 Round type: $\Phi = (x + y) / 2$ $X = X$ 3.2 Line type: (A	Y	$Φ \le 0.10$ $0.10 < Φ \le 0.20$ $0.20 < Φ \le 0.25$ $0.25 < Φ$	Acceptable Q TY Accept no dense 2 1 0	2.5
	(non-display)	→ L W	Length L≦3.0 L≦2.5	$\begin{tabular}{ll} Width \\ W \le 0.02 \\ 0.02 < W \le 0.03 \\ 0.03 < W \le 0.05 \\ 0.05 < W \\ \end{tabular}$	Acceptable Q TY Accept no dense  2 As round type	2.5
04	Polarizer bubbles	If bubbles are vis judge using black specifications, no to find, must che specify direction.	k spot ot easy ck in	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65
10	PCB · COB desig	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul>	2.5 2.5 0.65 2.5 0.65 2.5 2.5
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to	
12	General appearance	sever.  12.6 The residual rosin or tin oil of soldering (component or chip	2.5
	арроаганоо	component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on	
		packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	0.00
		12.12 Visual defect outside of VA is not considered to be rejection.	

### 11.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)

### 12.Material List of Components for RoHs

1. Midas hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do

not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to PoUS						

Above limited value is set up according to RoHS.

#### 2.Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250 ,30 seconds Max.;

Connector soldering wave or hand soldering: 320, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5

Recommended customer's soldering temp. of connector: 280, 3 seconds.

# 13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

